

# OKI semiconductor

## MSM2965RS

65,536 BITS STATIC 64K MASK ROM

### GENERAL DESCRIPTION

The MSM2965RS is a 65536-bits static, N channel MOS Read only memory organized as 8,192 words by 8 bits. The three-state outputs and TTL inputs/outputs level allow for direct interface with common system bus structures. The MSM2965RS single +5 V power supply and 300 ns access time are both ideal for usage with high performance microcomputers.

CS<sub>1</sub> may be defined by customer and fixed during the masking process.

ROM DATA Accepting flow from customer.

Preparing next two in customer's side

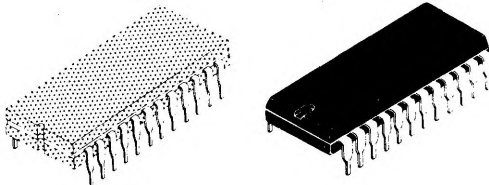
- 1) Two master devices, programming finished 64K EP. ROM or two 32K EP. ROMs.
- 2) Chip select CS logic table.

After received customer's ROM DATA, print out ROM DATA in Hex CODE and copy finished 64K EP. ROM or two 32K EP. ROMs send to customer.

Verified ROM DATA in customer's side, OKI send engineering samples mask programed customer's ROM DATA.

### FEATURES

- |                     |   |                  |   |
|---------------------|---|------------------|---|
| • Organization      | 8192 W x 8 bit  | • Output Voltage | V <sub>OH</sub> = 2.4 V Min.,<br>V <sub>OL</sub> = 0.4 V Max. |
| • Static Operation  | No clocks required  | • Package        | 24 PIN DIP  |
| • Supply Voltage    | 5 V ± 10%   |                  |   |
| • Access Time       | 300 ns Max.   |                  |   |
| • Power Dissipation | 687 mW Max.   |                  |   |
| • Input Voltage     | V <sub>IH</sub> = 2.0 V Min.,<br>V <sub>IL</sub> = 0.8 V Max. |                  |   |

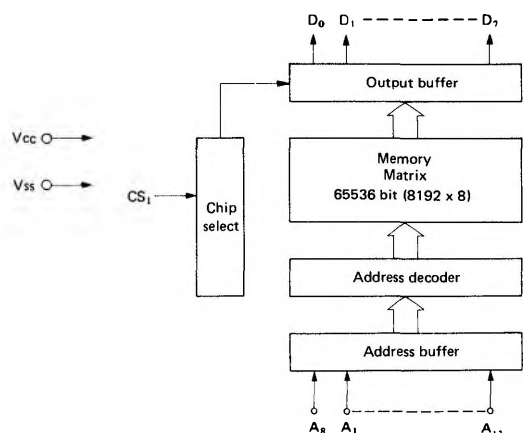


### PIN CONFIGURATION

A <sub>7</sub>	1	24	V <sub>CC</sub>
A <sub>6</sub>	2	23	A <sub>8</sub>
A <sub>5</sub>	3	22	A <sub>9</sub>
A <sub>4</sub>	4	21	A <sub>12</sub>
A <sub>3</sub>	5	20	CS
A <sub>2</sub>	6	19	A <sub>10</sub>
A <sub>1</sub>	7	18	A <sub>11</sub>
A <sub>0</sub>	8	17	D <sub>7</sub>
D <sub>0</sub>	9	16	D <sub>6</sub>
D <sub>1</sub>	10	15	D <sub>5</sub>
D <sub>2</sub>	11	14	D <sub>4</sub>
V <sub>SS</sub>	12	13	D <sub>3</sub>

Note: CS is programmable CHIP SELECTS.

### FUNCTIONAL BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	V <sub>CC</sub>	-0.5 to +7.0	V
Input Voltage	V <sub>I</sub>	-0.5 to +7.0	V
Output Voltage	V <sub>O</sub>	-0.5 to +7.0	V
Operating Temperature	T <sub>opr</sub>	0 to +70	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

## RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	4.5	5.0	5.5	V
"H" Input Voltage	V <sub>IH</sub>	2.0		V <sub>CC</sub>	V
"L" Input Voltage	V <sub>IL</sub>	-0.5		0.8	V

## AC OPERATING CHARACTERISTICS

(V<sub>CC</sub> = 5 V ± 10%, V<sub>SS</sub> = 0 V, T<sub>a</sub> = 0°C to +70°C)

Parameter	Symbol	Min.	Max.	Unit
Read Cycle time	t <sub>CYC</sub>	300		ns
Address Access time	t <sub>ACC</sub>		300	ns
Chip Select Access time	t <sub>CS</sub>		100	ns
Output Disable Delay time	t <sub>DF</sub>		100	ns

## DC CHARACTERISTICS

(V<sub>CC</sub> = 5 V ± 10%, V<sub>SS</sub> = 0 V, T<sub>a</sub> = 0°C to +70°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
"H" Input Voltage	V <sub>IH</sub>		2.0		V <sub>CC</sub>	V
"L" Input Voltage	V <sub>IL</sub>		-0.5		0.8	V
"H" Output Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -100μA	2.4			V
"L" Output Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 1.6 mA			0.4	V
Input Leak Current	I <sub>LI</sub>	V <sub>I</sub> = 0 ~ V <sub>CC</sub>			10	μA
Output Leak Current	I <sub>LO</sub>	V <sub>O</sub> = 0 ~ V <sub>CC</sub>			10	μA
Power Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 5.5V			125	mA
Input Capacity	C <sub>i</sub>	V <sub>I</sub> = 0V, V <sub>O</sub> = 0V f = 1 MHz T <sub>a</sub> = 25°C			6	pF
Output Capacity	C <sub>o</sub>				12	pF

$V_{IH} = 2.0V, V_{IL} = 0.8V, V_{OH} = 2.0V, V_{OL} = 0.8V$   
Output Load = 1 TTL GATE + 100PF

